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PATENT NUMBER

J.S. **UTILITY** Patent Application

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AP	PLICATION NO. 09/897820	CONT/PRIOR D	438 438	SUBCLASS	ART UNIT 28-1:2	EXAMINER R	+T/1e
APPLICANTS	Alan Souc James Cas Kevin Hoy	tantini	-				
щ	Apparatus	and meth	nods for	semiconduc	tor wafer	processing	equipment

ISSUING CLASSIFICATION						
ORIGINAL			CROSS REFERENCE(S)			
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TERMINAL	DRAWINGS			CLAIMS ALLOWED		
L_J DISCLAIMER	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.	
☐ The term of this patent subsequent to (date)			,	NOTICE OF AL	LOWANCE MAILED	
has been disclaimed.	(Assistant I	Examiner)	(Date)			
The term of this patent shall not extend beyond the expiration date						
of U.S Patent. No			l	ISSUE FEE		
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